

# **DATASHEET**

# Technical Data Sheet Top Phototransistor EAPPL 3527A0

#### **Features**

- Fast response time
- High photo sensitivity
- Small junction capacitance
- Package in 8mm tape on 7" diameter reels.
- Compatible with infrared and vapor phase reflow solder process.
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

#### **Description**

• EAPPL3527A0 is a high speed silicon NPN epitaxial planar phototransistor in a compact surface-mountable package. It's compatible with automatic placement equipment and can withstand IR reflow, vapor phase reflow, and wave solder processes.

### **Applications**

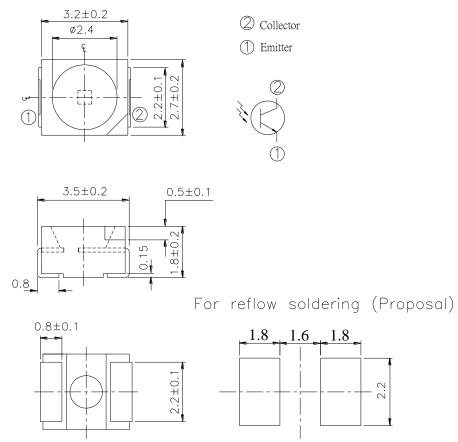
- Miniature switch
- Counters and sorter
- Position sensor
- Infrared applied system

#### **Device Selection Guide**

Device No.	Chip Material	Lens Color
EAPPL3527A0	Silicon	Black



# **Package Dimensions**



### **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Collector-Emitter Voltage	$V_{CEO}$	30	V
Emitter-Collector-Voltage	$V_{ECO}$	5	V
Collector Current	$I_{C}$	20	mA
Operating Temperature	$T_{opr}$	-25 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	T <sub>stg</sub>	-40 <b>~</b> +100	$^{\circ}\!\mathbb{C}$
Soldering Temperature	T <sub>sol</sub>	260	$^{\circ}\!\mathbb{C}$
Power Dissipation at(or below) 25°C Free Air Temperature	P <sub>c</sub>	75	mW

**Notes:** \*1:Soldering time ≤ 5 seconds.



# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Rang Of Spectral Bandwidth	λ 0.5	700		1100	nm	
Wavelength Of Peak Sensitivity	λ <sub>P</sub>		940		nm	
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	30			V	$I_C=100\mu$ A Ee=0mW/cm <sup>2</sup>
Emitter-Collector Breakdown Voltage	$BV_{ECO}$	5			V	$I_E=100\mu$ A $Ee=0mW/cm^2$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			0.4	V	I <sub>C</sub> =2mA Ee=1mW/cm <sup>2</sup>
Collector Dark Current	$I_{CEO}$			100	nA	V <sub>CE</sub> =20V Ee=0mW/cm <sup>2</sup>
On State Collector Current	I <sub>C(ON)</sub>	16		80	mA	$V_{\text{CE}}=5V$ $Ee=0.1\text{mW/cm}^2$
Rise Time	$t_{\rm r}$		15		C	$V_{\text{CE}}=5V$
Fall Time	$t_{\mathrm{f}}$		15		μS	$I_{C}=1 \text{ mA}$ $R_{L}=1000 \Omega$

# Rank

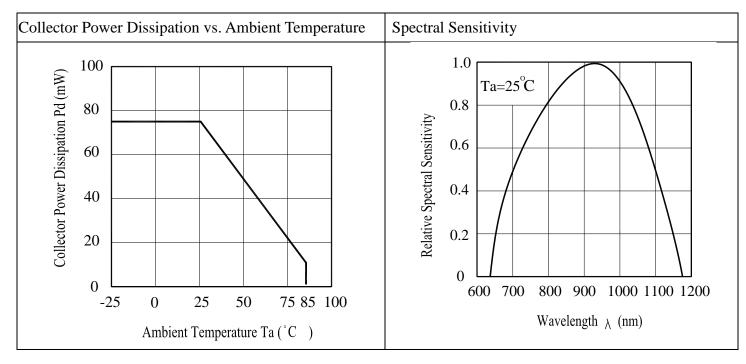
Condition :  $V_{CE}=5V$ ,  $Ee=0.1 \text{mW}/\text{cm}^2$ 

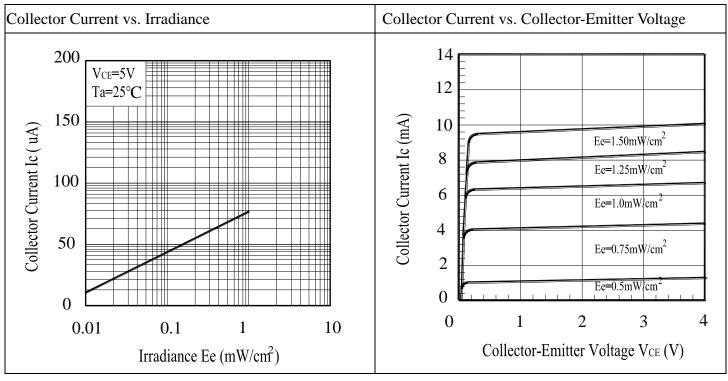
Unit: µ A

Bin Number	Bin2	Bin3	Bin4
Min	16	25	40
Max	32	50	80



### Typical Electrical/Optical/Characteristics Curves







#### Precautions For Use

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

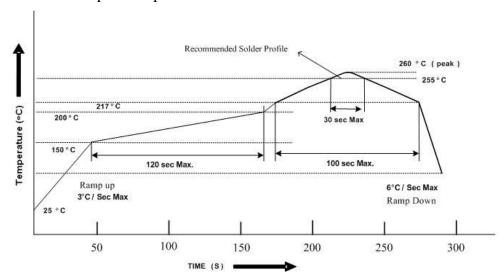
#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for Min 24 hours.

### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

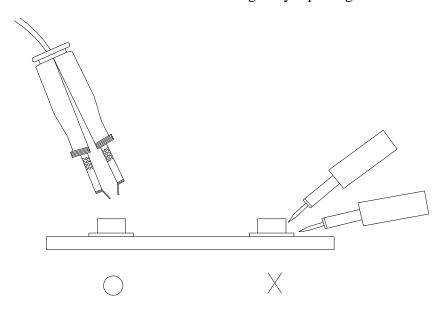


### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

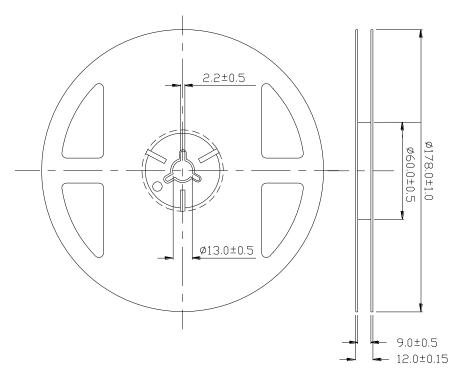
### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



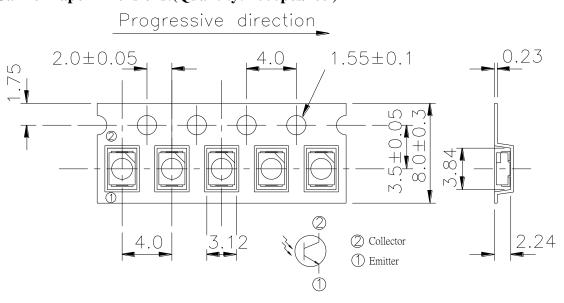


# **Package Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

### 2. Carrier Tape Dimensions:(Quantity: 2000pcs/reel)

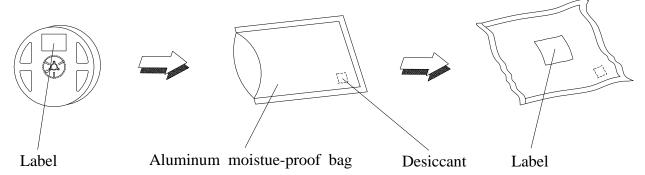


TOLERANCES UNLESS DIMENSION±0.1 ANGLE±0.5 UNIT:mm

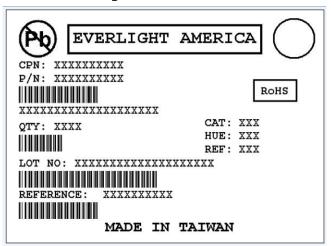
**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm



# **Packing Procedure**



# **Label Form Specification**



CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

**REF:** Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

### **Notes**

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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